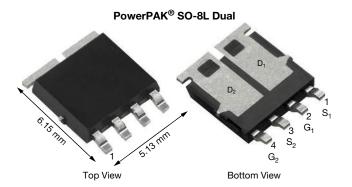
SQJB04ELP

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Vishay Siliconix

Automotive Dual N-Channel 40 V (D-S) 175 °C MOSFET



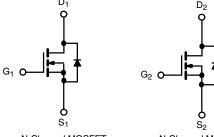
PRODUCT SUMMARY	
V _{DS} (V)	40
$R_{DS(on)} (\Omega)$ at $V_{GS} = 10 V$	0.0110
$R_{DS(on)} (\Omega)$ at $V_{GS} = 4.5 V$	0.0146
I _D (A) per leg	30
Configuration	Dual
Package	PowerPAK SO-8L

FEATURES

- TrenchFET[®] power MOSFET
- AEC-Q101 qualified
- 100 % R_q and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



RoHS COMPLIANT HALOGEN FREE



N-Channel MOSFET

D.

S₂ N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	S (T _C = 25 °C, unless	s otherwise noted	i)		
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	40	v	
Gate-source voltage		V _{GS}	± 20	v	
Continuous drain current	T _C = 25 °C ^a	1	30		
Continuous drain current	T _C = 125 °C	Ι _D	22		
Continuous source current (diode conduction) a		I _S	25	А	
Pulsed drain current ^b		I _{DM}	120		
Single pulse avalanche current	L = 0.1 mH	I _{AS}	14		
Single pulse avalanche energy		E _{AS}	9.8	mJ	
Maximum annualization b	T _C = 25 °C	D	27	w	
Maximum power dissipation ^b	T _C = 125 °C	P _D	9	vv	
Operating junction and storage temperature	range	T _J , T _{stg}	-55 to +175	°C	
Soldering recommendations (peak temperatu	ıre) ^{d, e}		260		

THERMAL RESISTANCE RATINGS				
PARAMETER		SYMBOL	LIMIT	UNIT
Junction-to-ambient	PCB mount ^c	R _{thJA}	85	°C/W
Junction-to-case (drain)		R _{thJC}	5.5	0/10

Notes

- a. Package limited
- b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %
- c. When mounted on 1" square PCB (FR4 material)
- d. See solder profile (<u>www.vishay.com/doc?73257</u>). The PowerPAK SO-8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components

SQJB04ELP

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SPECIFICATIONS (T_C = 25 °C, unless otherwise noted)

SPECIFICATIONS ($1_{C} = 25$ °C, utilies otherwise noted)									
SYMBOL	TES	MIN.	TYP.	MAX.	UNIT				
V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$		40	-	-	V			
V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$		1.2	1.7	2.2	v			
I _{GSS}	$V_{DS} =$	0 V, $V_{GS} = \pm 20 V$	-	-	± 100	nA			
	$V_{GS} = 0 V$	V _{DS} = 40 V	-	-	1				
I _{DSS}	$V_{GS} = 0 V$	V_{DS} = 40 V, T_{J} = 125 °C	-	-	50	μA			
	$V_{GS} = 0 V$	$V_{DS} = 40 \text{ V}, \text{ T}_{J} = 175 ^{\circ}\text{C}$	I	-	150				
I _{D(on)}	$V_{GS} = 10 V$	$V_{DS} \ge 5 V$	25	-	-	А			
	$V_{GS} = 10 V$	I _D = 5 A	I	0.0078	0.0110				
P	$V_{GS} = 4.5 V$	I _D = 3 A	I	0.0113	0.0146	μA A A A A A A A A V ns nC ns			
DS(on)	$V_{GS} = 10 V$	I _D = 5 A, T _J = 125 °C	-	-	0.0150				
	$V_{GS} = 10 V$	I _D = 5 A, T _J = 175 °C	-	-	0.0180				
g fs	V _{DS}	= 15 V, I _D = 5 A	I	30	-	S			
C _{iss}		V _{DS} = 25 V, f = 1 MHz	-	751	1055	pF			
Coss	$V_{GS} = 0 V$		I	223	320				
C _{rss}			-	22	35				
Qg			-	13.1	20				
Q _{gs}	$V_{GS} = 10 \text{ V}$ $V_{DS} = 20 \text{ V}, I_D = 1.5 \text{ A}$		-	2.4	-	nC			
Q _{gd}			-	2.1	-				
R _g	f = 1 MHz		1.65	3.33	5.10	Ω			
t _{d(on)}	V_{DD} = 20 V, R _L = 13.33 Ω I _D \cong 1.5 A, V _{GEN} = 10 V, R _g = 1 Ω		-	9	15				
t _r			-	5	10	ns			
t _{d(off)}			I	19	30				
t _f			I	5	10				
teristics ^b									
I _{SM}			-	-	120	А			
V _{SD}	$I_F = 5 \text{ A}, V_{GS} = 0 \text{ V}$		I	0.88	1.2	V			
t _{rr}			-	20	40	ns			
Qrr			-	10	20	nC			
ta	IF = 3 /	$h, u/ul = 100 A/\mu s$	-	10	-	ns			
t _b	1		-	10	-	ns			
I _{RM(REC)}			-	-0.85	-	А			
	SYMBOL V _{DS} V _{GS} (th) I _{GSS} I _{DSS} I _{D(on)} R _{DS(on)} gfs C _{iss} C _{iss} C _{rss} Q _g Q _g Q _g Q _g Q _g Q _g C _{iss} C _{rss} Q _g Q _g	$\begin{tabular}{ c c c c } \hline SYMBOL & TES \\ \hline V_{DS} & V_{GS} = \\ \hline V_{GS}(th) & V_{DS} = \\ \hline V_{GS}(th) & V_{DS} = \\ \hline I_{DSS} & V_{GS} = 0 V \\ \hline V_{GS} = 10 V \\ \hline V_{DD} = 2 \\ \hline I_{SM} \\ \hline V_{SD} & I_{F} = \\ \hline I_{Tr} \\ \hline I_{C} = 1.5 A, \\ \hline I_{F} = 3 A \\ \hline V_{SD} \\ \hline V_{SD} & I_{F} = \\ \hline V_{SD} \\ \hline V_{SD} & I_{F} = \\ \hline V_{SD} \\ \hline V_{F} = 3 A \\ \hline V_{SD} \\ \hline$	$\begin{tabular}{ c c c c } \hline SYMBOL & TEST CONDITIONS \\ \hline V_{DS} & V_{GS} = 0 \ V, \ I_D = 250 \ \mu A \\ \hline V_{DS} & V_{DS} = 0 \ V, \ V_{GS} = \pm 20 \ V \\ \hline V_{DS} = 0 \ V, \ V_{DS} = 0 \ V, \ V_{DS} = 40 \ V \\ \hline V_{DS} = 0 \ V & V_{DS} = 40 \ V, \ T_J = 125 \ ^{\circ}C \\ \hline V_{GS} = 0 \ V & V_{DS} = 40 \ V, \ T_J = 175 \ ^{\circ}C \\ \hline V_{GS} = 10 \ V & I_D = 5 \ A \\ \hline V_{GS} = 10 \ V & I_D = 5 \ A \\ \hline V_{GS} = 10 \ V & I_D = 5 \ A, \ T_J = 125 \ ^{\circ}C \\ \hline V_{GS} = 10 \ V & I_D = 5 \ A, \ T_J = 125 \ ^{\circ}C \\ \hline V_{GS} = 10 \ V & I_D = 5 \ A, \ T_J = 125 \ ^{\circ}C \\ \hline V_{GS} = 10 \ V & I_D = 5 \ A, \ T_J = 125 \ ^{\circ}C \\ \hline V_{GS} = 10 \ V & I_D = 5 \ A, \ T_J = 125 \ ^{\circ}C \\ \hline V_{GS} = 10 \ V & I_D = 5 \ A, \ T_J = 125 \ ^{\circ}C \\ \hline V_{GS} = 10 \ V & I_D = 5 \ A, \ T_J = 125 \ ^{\circ}C \\ \hline V_{GS} = 10 \ V & I_D = 5 \ A, \ T_J = 175 \ ^{\circ}C \\ \hline V_{GS} = 10 \ V & I_D = 5 \ A, \ T_J = 175 \ ^{\circ}C \\ \hline V_{GS} = 10 \ V & I_D = 5 \ A, \ T_J = 175 \ ^{\circ}C \\ \hline V_{GS} = 10 \ V & V_{DS} = 20 \ V, \ I_D = 1.5 \ A \\ \hline \hline D_{Gg} \\ \hline Q_{gg} \\ \hline Q_{gg} \\ \hline Q_{gg} \\ \hline Q_{gg} \\ \hline T_r \\ \hline U_{DD} = 20 \ V, \ R_L = 13.33 \ \Omega \\ I_D \equiv 1.5 \ A, \ V_{GEN} = 10 \ V, \ R_g = 1 \ \Omega \\ \hline t_f \\ \hline t_f \\ \hline t_f \\ \hline t_{rr} \\ \hline Q_{rr} \\ \hline I_{F} = 3 \ A, \ di/dt = 100 \ A/\mu S \\ \hline I_F = 5 \ A, \ V_{GS} = 0 \ V \\ \hline \ I_{Tr} \\ \hline Q_{rr} \\ \hline I_F = 3 \ A, \ di/dt = 100 \ A/\mu S \\ \hline \ T_{Tr} \\ \hline D_{Tr} \\ \hline T_{Tr} \\ \hline $	$\begin{tabular}{ c c c c c } \hline $YMBOL$ TEST CONDITIONS$ MIN. \\ \hline V_{DS} V_{GS} = 0 V, I_D = 250 \ \mu A$ 40 \\ \hline $V_{GS(th)$}$ V_{DS} = V_{GS, I_D} = 250 \ \mu A$ 1.2 \\ \hline I_{GSS V_{DS} = 0 V, V_{GS} = \pm 20 V$ - $V_{GS} = \pm 20 V$ - $V_{GS} = 0 V$ V_{DS} = 40 V$ - $V_{CS} = 0 V$ V_{DS} = 40 V$ - $V_{CS} = 0 V$ V_{DS} = 40 V$ 1.2 \\ \hline $V_{GS} = 0 V$ V_{DS} = 40 V, T_J = 125 \ ^{\circ}C$ - $V_{GS} = 0 V$ V_{DS} = 40 V, T_J = 175 \ ^{\circ}C$ - $V_{GS} = 10 V$ V_{DS} = 5 V$ 25 \\ \hline $V_{GS} = 10 V$ V_{DS} = 5 A, T_J = 125 \ ^{\circ}C$ - $V_{GS} = 10 V$ I_D = 5 A, T_J = 125 \ ^{\circ}C$ - $V_{GS} = 10 V$ I_D = 5 A, T_J = 125 \ ^{\circ}C$ - $V_{GS} = 10 V$ I_D = 5 A, T_J = 175 \ ^{\circ}C$ - $V_{GS} = 10 V$ I_D = 5 A, T_J = 175 \ ^{\circ}C$ - $V_{GS} = 10 V$ I_D = 5 A, T_J = 175 \ ^{\circ}C$ - $V_{GS} = 10 V$ I_D = 5 A, T_J = 175 \ ^{\circ}C$ - $V_{GS} = 10 V$ I_D = 5 A, T_J = 175 \ ^{\circ}C$ - $V_{GS} = 10 V$ I_D = 5 A, T_J = 175 \ ^{\circ}C$ - $V_{GS} = 10 V$ I_D = 5 A, T_J = 175 \ ^{\circ}C$ - $V_{GS} = 10 V$ I_D = 5 A, T_J = 175 \ ^{\circ}C$ - $V_{GS} = 10 V$ I_D = 5 A, T_J = 175 \ ^{\circ}C$ - $V_{GS} = 10 V$ I_D = 5 A, T_J = 175 \ ^{\circ}C$ - $V_{GS} = 10 V$ I_D = 5 A, T_J = 175 \ ^{\circ}C$ - $V_{GS} = 0 V$ V_{DS} = 20 V, I_D = 1.5 A$ - $V_{CS} = $V_{GS} = 10 V$ V_{DS} = 20 V, I_D = 1.5 A$ - $V_{CS} = $V_{CT} = $V_{DD} = 20 V, R_L = 13.33 \ \Omega$ - $V_{CT} = $V_{DD} = 20 V, R_L = 13.33 \ \Omega$ - $V_{CT} = $V_{CT} = $V_{CT} = $V_{DD} = 20 V, R_L = 13.33 \ \Omega$ - $V_{CT} = V	$\begin{tabular}{ c c c c c } \hline $YMBOL$ $TEST CONDITIONS$ $MIN. $TYP.$ $TYP.$ V_{DS} $V_{GS} = 0 V, $I_D = 250 μA 40 $-$$$$$$$$$$$$$$$$$$$$$$$$$$$$$$$$	$\begin{tabular}{ c c c c c c } \hline \mathbf{YMBOL} & $\mathbf{TEST CONDITIONS}$ & \mathbf{MIN}, \mathbf{TYP}, \mathbf{MAX}, $$ $$ $$ $$ $$ $$ $$ $$ $$ $$ $$ $$ $$			

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

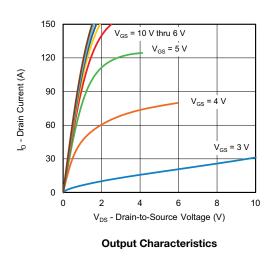
b. Guaranteed by design, not subject to production testing

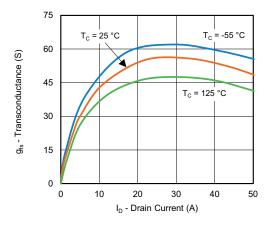
c. Independent of operating temperature

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

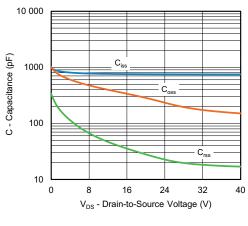


TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)

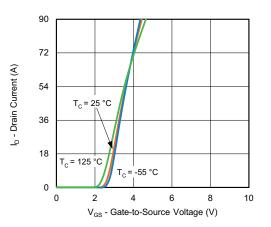




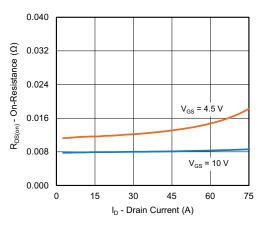
Transconductance



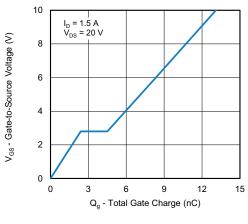




Transfer Characteristics



On-Resistance vs. Drain Current



Gate Charge

S20-0104-Rev. A, 02-Mar-2020

3

Document Number: 77326

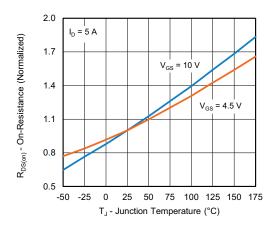
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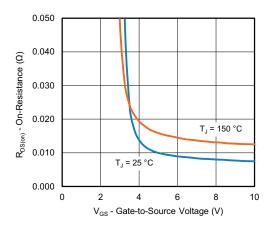
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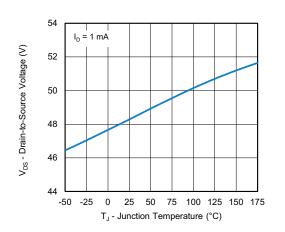
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



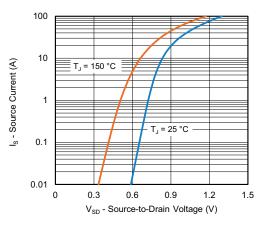
On-Resistance vs. Junction Temperature



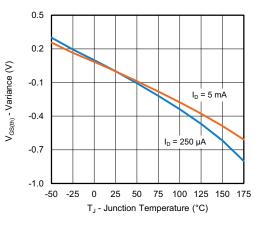
On-Resistance vs. Gate-to-Source Voltage



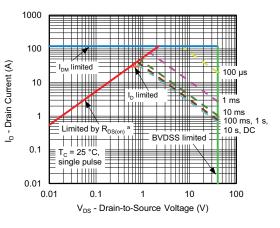
Drain Source Breakdown vs. Junction Temperature



Source Drain Diode Forward Voltage



Threshold Voltage



Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

S20-0104-Rev. A, 02-Mar-2020

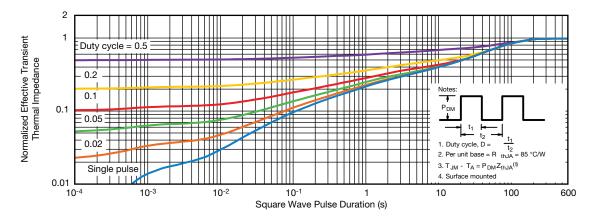
4

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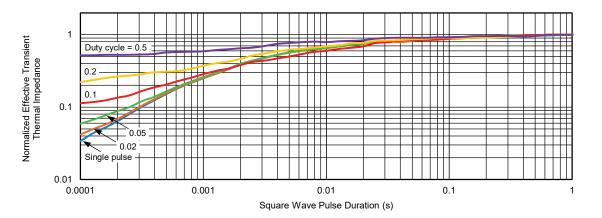
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THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Note

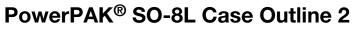
- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

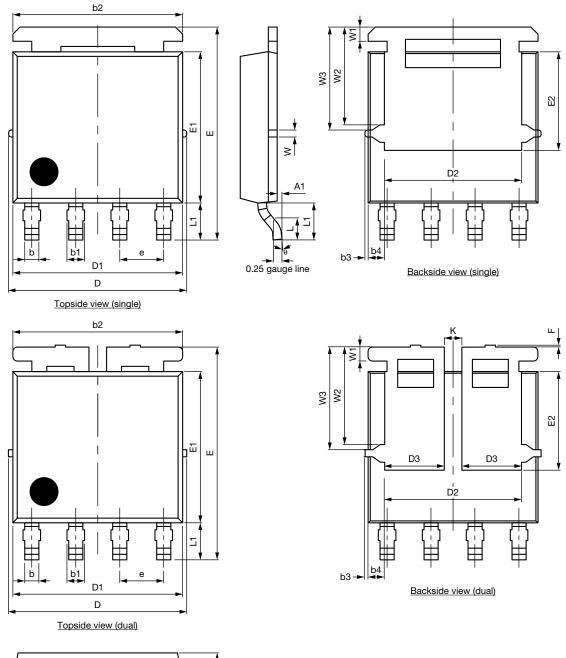
are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

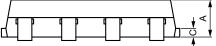
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?77326.

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1 For technical questions, contact: <u>pmostechsupport@vishay.com</u>

Package Information



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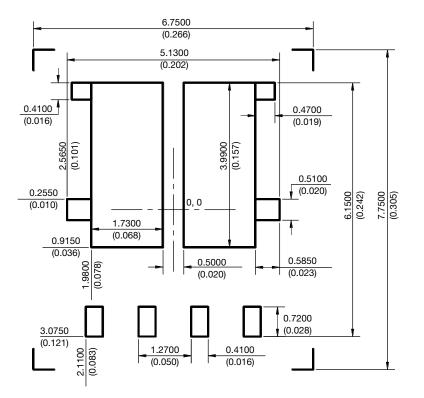
DIM.	MILLIMETERS			INCHES				
	MIN.	MIN. NOM. MAX.			MIN. NOM. MAX			
А	1.00	1.07	1.14	0.039	0.042	0.045		
A1	0.00	-	0.127	0.00	-	0.005		
b	0.33	0.41	0.48	0.013	0.016	0.019		
b1	0.44	0.51	0.58	0.017	0.020	0.023		
b2	4.80	4.90	5.00	0.189	0.193	0.197		
b3		0.094			0.004			
b4		0.47			0.019			
С	0.20	0.25	0.30	0.008	0.010	0.012		
D	5.00	5.13	5.25	0.197	0.202	0.207		
D1	4.80	4.90	5.00	0.189	0.193	0.197		
D2	3.86	3.96	4.06	0.152	0.156	0.160		
D3	1.63	1.73	1.83	0.064	0.068	0.072		
е		1.27 BSC		0.050 BSC				
E	6.05	6.15	6.25	0.238	0.242	0.246		
E1	4.27	4.37	4.47	0.168	0.172	0.176		
E2	2.75	2.85	2.95	0.108	0.112	0.116		
F	-	-	0.15	-	-	0.006		
L	0.62	0.72	0.82	0.024	0.028	0.032		
L1	0.92	1.07	1.22	0.036	0.042	0.048		
К		0.51			0.020			
W		0.23			0.009			
W1	0.41			0.016				
W2	2.82			0.111				
W3		2.96			0.117			
θ	0°	-	10°	0°	-	10°		

Note

• Millimeters will govern



RECOMMENDED MINIMUM PAD FOR PowerPAK® SO-8L DUAL



Recommended Minimum Pads Dimensions in mm (inches) Keep-out 6.75 (0.266) x 7.75 (0.305)

Revision: 07-Feb-12



Vishay

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